

03/08/02

132 U.S. PAT. & TM. OFF.
WASHINGTON, DC 20231
Sir:IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
REQUEST FOR FILING APPLICATION UNDER 37 CFR 1.53(b)
WITHOUT FILING FEE OR EXECUTED INVENTOR'S DECLARATIONAssistant Commissioner for Patents
Washington, DC 20231

Atty. Dkt. 900-421

Date: March 8, 2002

11017 U.S. PTO

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03/08/02

This is a request for filing a new PATENT APPLICATION under Rule 53(b) entitled:
SEMICONDUCTOR DEVICE

without a filing fee and/or without an executed inventor's oath/declaration.

This application is made by the below identified inventor(s). Attached hereto are the following papers:

- ☒ An abstract together with
20 pages of specification and claims including
7 numbered claims and also attached is/are
2 sheets of accompanying drawings.
- ☒ This application is based on the following prior foreign application(s):

Application No.	Country
2001-64950	Japan

Filing Date
8 March 2001

respectively, the entire content of which is hereby incorporated by reference in this application, and priority is hereby claimed therefrom.

- ☐ This application is based on the following prior provisional application(s):

Application No.	Filing Date
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respectively, the entire content of which is hereby incorporated by reference in this application, and priority is hereby claimed therefrom.

- ☒ Certified copies of foreign applications attached.

This application is a ☐ continuation/☐ division/☐ continuation-in-part of application Serial No. , filedPlease amend the specification by inserting before the first line: --This application is a ☐ continuation/☐ division/☐ continuation-in-part of application Serial No. , filed , the entire content of which is hereby incorporated by reference in this application.--

Please amend the specification by inserting before the first line: --This is a continuation of PCT application No. , filed , the entire content of which is hereby incorporated by reference in this application.--

Please amend the specification by inserting before the first line: --This application claims the benefit of U.S.

Provisional Application No. , filed , the entire content of which is hereby incorporated by reference in this application.--

Preliminary amendment to claims (attached hereto), to be entered before calculation of the fee.

Also attached. Information Disclosure Statement, Form PTO-1449 and attached references.

Inventor's Signature: _____	Date: _____
Inventor: Tomoya (first) MI BABA (last) Japan (citizenship)	
Residence: (city) Ikoma-shi (state/country) Japan	
Post Office Address: 8-17, Asukanomimami 3-chome, Ikoma-shi, Japan	
(Zip Code) Nara 630-0133	

2. Inventor's Signature: _____ Date: _____

Inventor: Katsumasa (first) MI FUJII (last) Japan (citizenship)

Residence: (city) Yamatokoriyama-shi (state/country) Japan

Post Office Address: 30-9, Izumihara-cho, Yamatokoriyama-shi, Japan

(Zip Code) Nara 639-1056

NOTE: FOR ADDITIONAL INVENTORS, check box ☒ and attach sheet with same information.1100 North Glebe Road, 8th Floor
Arlington, Virginia 22201-4714
Telephone: (703) 816-4000
Facsimile: (703) 816-4100
HWB:maw

NIXON & VANDERHYE P.C.

By Atty: H. Warren Burnam, Jr., Reg. No. 29,366

Signature: 

609108

3. Inventor's Signature: _____ Date: _____
Inventor: Akiyoshi MUTOU Japan
(first) (last) (citizenship)
Residence: (city) Konan-shi (state/country) Japan
Post Office Address: 271, Chiyomi, Kusai-cho, Konan-shi, Japan
(Zip Code) Aichi 483-8077

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